

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Gerard M. Col</td><td>09/25/2008</td></tr><tr><td>G. Glenn Henry</td><td>09/25/2008</td></tr><tr><td>Rodney E. Hooker</td><td>09/25/2008</td></tr><tr><td>Terry Parks</td><td>09/25/2008</td></tr></tbody></table>	Name	Execution Date	Gerard M. Col	09/25/2008	G. Glenn Henry	09/25/2008	Rodney E. Hooker	09/25/2008	Terry Parks	09/25/2008	
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Gerard M. Col	09/25/2008										
G. Glenn Henry	09/25/2008										
Rodney E. Hooker	09/25/2008										
Terry Parks	09/25/2008										
RECEIVING PARTY DATA											
Name:	VIA Technologies, Inc.										
Street Address:	8F, 535, Chung-Cheng Road										
City:	Taipei										
State/Country:	TAIWAN										
Postal Code:	231										
PROPERTY NUMBERS Total: 1											
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12233261</td></tr></tbody></table>	Property Type	Number	Application Number:	12233261							
Property Type	Number										
Application Number:	12233261										
CORRESPONDENCE DATA											
Fax Number:	(719)623-0141										
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
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Correspondent Name:	Taysie J. Locke										
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Address Line 4:	Colorado Springs, COLORADO 80906										
ATTORNEY DOCKET NUMBER:	CNTR.2387										
NAME OF SUBMITTER:	Taysie J. Locke										
Total Attachments: 2 source=CNTR-2387_Assignment#page1.tif											

CH \$40.00 12233261

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PATENT
REEL: 021610 FRAME: 0260

ASSIGNMENT

TITLE OF INVENTION	MICROPROCESSOR WITH FUSED STORE ADDRESS/STORE DATA MICROINSTRUCTION
DOCKET NUMBER	CNTR.2387

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on even date herewith;

AND WHEREAS, VIA Technologies, Inc., together with any successors, legal representatives, or assigns thereof, with its principal office at 8F, 535 Chung-Cheng Road, Hsin-Tien, Taipei 231, Taiwan, wants to acquire the entire right, title and interest in and to the said invention(s), and to the said application and any Letters Patent that may issue thereon;

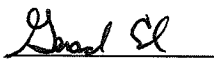


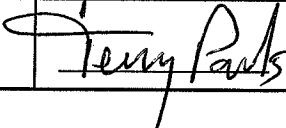
NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledge, I have sold, assigned, transferred and set over, and do hereby sell, assign, transfer and set over to the said VIA Technologies, Inc., its successors and assigns, the entire right, title and interest in and to the said invention and in and to the said application and all patents which may be granted thereon, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I/we hereby authorize and request the Commissioner of Patents, and any officials of foreign countries whose duty it is to issue patents on applications, to issue all patents for said invention, or patents resulting therefrom, insofar as my interest in concerned, to the said VIA Technologies, Inc. as assignee of my entire right, title and interest;

I ALSO HEREBY sell and assign to VIA Technologies, Inc., its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights;

AND I HEREBY covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith;

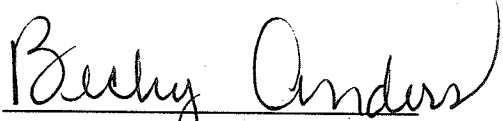
AND I HEREBY further covenant that I will communicate to said VIA Technologies, Inc., or to its successors, assigns and legal representatives, any facts known to me respecting said invention, and at the expense of said VIA Technologies, Inc., testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said VIA Technologies, Inc., its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

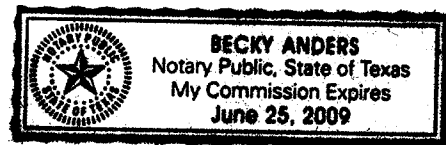
IN WITNESS WHEREOF, I hereunto set my hand this day and year:

INVENTOR NAME(S)	RESIDENCE AND MAILING ADDRESS	CITIZENSHIP	SIGNATURE	DATE
GERARD M. COL	11008 CONCHOS TR. AUSTIN, TX 78726	US		9/25/08
G. GLENN HENRY	411 LAKE CLIFF TRAIL AUSTIN, TX 78746	US		9/25/08
RODNEY E. HOOKER	12632 CALISTOGA WAY AUSTIN, TX 78732	US		9/25/08
TERRY PARKS	#6 CARRIAGE HOUSE LANE AUSTIN, TX 78737	US		9-25-08

On Sept. 25, 2008, before me, Becky Anders, notary public, personally appeared the above named individuals personally known to me or proved to me on the basis of satisfactory evidence, to be the person(s) whose name(s) is/are subscribed to the within instrument and acknowledged to me that he/she/they executed the same in his/her/their authorized capacity(ies), and that by his/her/their signature(s) on the instrument the person(s), or the entity upon behalf of which the person(s) acted, executed the instrument.

WITNESS my hand and official seal.


SIGNATURE OF NOTARY PUBLIC



PLACE NOTARY SEAL ABOVE